## ASSP For Power Supply Applications (Secondary battery) DC/DC Converter IC for Charging Li-ion battery

## MB3887

## - DESCRIPTION

The MB3887 is a DC/DC converter IC suitable for down-conversion, using pulse-width (PWM) charging and enabling output voltage to be set to any desired level from one cell to four cells.
These ICs can dynamically control the secondary battery's charge current by detecting a voltage drop in an AC adapter in order to keep its power constant (dynamically-controlled charging).
The charging method enables quick charging, for example, with the AC adapter during operation of a notebook PC.
The MB3887 provides a broad power supply voltage range and low standby current as well as high efficiency, making it ideal for use as a built-in charging device in products such as notebook PC.
This product is covered by US Patent Number 6,147,477.
■ FEATURES

- Detecting a voltage drop in the AC adapter and dynamically controlling the charge current (Dynamically-controlled charging)
- Output voltage setting using external resistor
- High efficiency
: 1 cell to 4 cells
- Wide range of operating supply voltages
: $96 \%$ (VIN = 19 V , Vo = 16.8 V )
- Output voltage setting accuracy
: 8 V to 25 V
- Charging current accuracy
$: 4.2 \mathrm{~V} \pm 0.74 \%\left(\mathrm{Ta}=-10^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$, per cell)
- Built-in frequency setting capacitor enables frequency setting using external resistor only
- Oscillation frequency range
: 100 kHz to 500 kHz
- Built-in current detection amplifier with wide in-phase input voltage range : 0 V to VCC
- In standby mode, leave output voltage setting resistor open to prevent inefficient current loss
- Built-in standby current function
: $0 \mu \mathrm{~A}$ (standard)
- Built-in soft-start function independent of loads
- Built-in totem-pole output stage supporting P-channel MOS FET devices
- One type of package (SSOP-24pin : 1 type)


## Application

- Notebook PC


## MB3887

## PIN ASSIGNMENT



## - PIN DESCRIPTION

| Pin No. | Symbol | I/O | Descriptions |
| :---: | :---: | :---: | :--- |
| 1 | - INC2 | I | Current detection amplifier (Current Amp2) input terminal. |
| 2 | OUTC2 | O | Current detection amplifier (Current Amp2) output terminal. |
| 3 | +INE2 | I | Error amplifier (Error Amp2) non-inverted input terminal. |
| 4 | - INE2 | I | Error amplifier (Error Amp2) inverted input terminal. |
| 5 | FB2 | O | Error amplifier (Error Amp2) output terminal. |
| 6 | VREF | O | Reference voltage output terminal. |
| 7 | FB1 | O | Error amplifier (Error Amp1) output terminal. |
| 8 | -INE1 | I | Error amplifier (Error Amp1) inverted input terminal |
| 9 | +INE1 | I | Error amplifier (Error Amp1) non-inverted input terminal. |
| 10 | OUTC1 | O | Current detection amplifier (Current Amp1) output terminal. |
| 11 | OUTD | O | With IC in standby mode, this terminal is set to "Hi-Z" to prevent loss <br> of current through output voltage setting resistance. <br> Set CTL terminal to "H" level to output "L" level. |
| 12 | -INC1 | I | Current detection amplifier (Current Amp1) input terminal. |
| 13 | +INC1 | I | Current detection amplifier (Current Amp1) input terminal. |
| 14 | CTL | I | Power supply control terminal. <br> Setting the CTL terminal at "L" level places the IC in the standby <br> mode. |
| 15 | FB3 | O | Error amplifier (Error Amp3) output terminal. |
| 16 | -INE3 | I | Error amplifier (Error Amp3) inverted input terminal. |
| 17 | RT | - | Triangular-wave oscillation frequency setting resistor connection <br> terminal. |
| 18 | VCC | - | Power supply terminal for reference power supply and control circuit. |
| 19 | VH | O | Power supply terminal for FET drive circuit (VH = VCC - 6 V) . |
| 20 | OUT | O | External FET gate drive terminal. |
| 21 | VCC (O) | - | Output circuit power supply terminal. |
| 22 | CS | - | Soft-start capacitor connection terminal. |
| 23 | GND | - | Ground terminal. |
| +INC2 | I | Current detection amplifier (Current Amp2) input terminal. |  |
| 24 |  |  |  |

## MB3887

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Conditions | Rating |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |
| Power supply voltage | Vcc | VCC, VCC (O) termina**2 | - | 28 | V |
| Output current | lout | - | - | 60 | mA |
| Peak output current | lout | $\begin{aligned} & \text { Duty } \leq 5 \% \\ & (\mathrm{t}=1 / \text { fosc } \times \text { Duty }) \end{aligned}$ | - | 700 | mA |
| Power dissipation | PD | $\mathrm{Ta} \leq+25^{\circ} \mathrm{C}$ | - | 740*1 | mW |
| Storage temperature | Tstg | - | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |

*1 : The package is mounted on the dual-sided epoxy board ( $10 \mathrm{~cm} \times 10 \mathrm{~cm}$ ).
*2 : For details, refer to " $\square$ THE SEQUENCE OF THE START-UP AND OFF OF THE POWER SUPPLY".
WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| Power supply voltage | Vcc | VCC, VCC (0) terminal* | 8 | - | 25 | V |
| Reference voltage output current | IREF | - | -1 | - | 0 | mA |
| VH terminal output current | IvH | - | 0 | - | 30 | mA |
| Input voltage | VINE | -INE1 to -INE3, +INE1, <br> +INE2 terminal | 0 | - | Vcc-1.8 | V |
|  | Vinc | $+ \text { INC1, +INC2, -INC1, }$ <br> -INC2 terminal | 0 | - | Vcc | V |
| OUTD terminal output voltage | Voutd | - | 0 | - | 17 | V |
| OUTD terminal output current | loutd | - | 0 | - | 2 | mA |
| CTL terminal input voltage | Vсть | - | 0 | - | 25 | V |
| Output current | lout | - | -45 | - | +45 | mA |
| Peak output current | lout | $\begin{aligned} & \text { Duty } \leq 5 \% \\ & (\mathrm{t}=1 / \text { fosc } \times \text { Duty }) \end{aligned}$ | -600 | - | +600 | mA |
| Oscillation frequency | fosc | - | 100 | 290 | 500 | kHz |
| Timing resistor | RT | - | 27 | 47 | 130 | $\mathrm{k} \Omega$ |
| Soft-start capacitor | Cs | - | - | 0.022 | 1.0 | $\mu \mathrm{F}$ |
| VH terminal capacitor | Cve | - | - | 0.1 | 1.0 | $\mu \mathrm{F}$ |
| Reference voltage output capacitor | Cref | - | - | 0.1 | 1.0 | $\mu \mathrm{F}$ |
| Operating ambient temperature | Ta | - | -30 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |

*: For details, refer to "■ THE SEQUENCE OF THE START-UP AND OFF OF THE POWER SUPPLY".
WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## ■ ELECTRICAL CHARACTERISTICS

| Parameter |  | Sym－ bol | Pin <br> No． | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min |  |  | Typ | Max |  |
| 1. <br> Reference voltage block ［REF］ | Output voltage |  | Vref1 | 6 | $\mathrm{Ta}=+25^{\circ} \mathrm{C}$ | 4.967 | 5.000 | 5.041 | V |
|  |  | Vref2 | 6 | $\mathrm{Ta}=-10^{\circ} \mathrm{C}$ to $+85{ }^{\circ} \mathrm{C}$ | 4.95 | 5.00 | 5.05 | V |
|  | Input stability | Line | 6 | $\mathrm{VCC}=8 \mathrm{~V}$ to 25 V | － | 3 | 10 | mV |
|  | Load stability | Load | 6 | $\mathrm{VREF}=0 \mathrm{~mA}$ to -1 mA | － | 1 | 10 | mV |
|  | Short－circuit output current | Ios | 6 | $\mathrm{VREF}=1 \mathrm{~V}$ | －50 | －25 | －12 | mA |
| 2. <br> Under voltage lockout protec－ tion circuit block ［UVLO］ | Threshold voltage | $V_{\text {TLH }}$ | 18 | $\begin{aligned} & \mathrm{VCC}=\mathrm{VCC}(\mathrm{O}), \\ & \mathrm{VCC}=\ldots \end{aligned}$ | 6.2 | 6.4 | 6.6 | V |
|  |  | $\mathrm{V}_{\text {THL }}$ | 18 | $\begin{aligned} & \mathrm{VCC}=\mathrm{VCC}(\mathrm{O}), \\ & \mathrm{VCC}=飞 \end{aligned}$ | 5.2 | 5.4 | 5.6 | V |
|  | Hysteresis width | $\mathrm{V}_{\mathrm{H}}$ | 18 | $\mathrm{VCC}=\mathrm{VCC}(\mathrm{O})$ | － | 1．0＊ | － | V |
|  | Threshold voltage | $\mathrm{V}_{\text {TLH }}$ | 6 | VREF $=$ 个 | 2.6 | 2.8 | 3.0 | V |
|  |  | $\mathrm{V}_{\text {THL }}$ | 6 | VREF＝そ | 2.4 | 2.6 | 2.8 | V |
|  | Hysteresis width | $\mathrm{V}_{\mathrm{H}}$ | 6 | － | － | 0.2 | － | V |
| 3. <br> Soft－start block ［SOFT］ | Charge current | Ics | 22 | － | －14 | －10 | －6 | $\mu \mathrm{A}$ |
| 4. <br> Triangular waveform os－ cillator circuit block ［OSC］ | Oscillation frequency | fosc | 20 | $\mathrm{RT}=47 \mathrm{k} \Omega$ | 260 | 290 | 320 | kHz |
|  | Frequency temperature stability | $\Delta \mathrm{f} / \mathrm{fdt}$ | 20 | $\mathrm{Ta}=-30^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | － | 1＊ | － | \％ |
| 5－1． <br> Error amplifier block <br> ［Error Amp1， <br> Error Amp2］ | Input offset voltage | Vıo | $\begin{gathered} 3,4, \\ 8,9 \end{gathered}$ | $\mathrm{FB} 1=\mathrm{FB} 2=2 \mathrm{~V}$ | － | 1 | 5 | mV |
|  | Input bias current | Ів | $\begin{gathered} \hline 3,4, \\ 8,9 \end{gathered}$ | － | －100 | －30 | － | nA |
|  | In－phase input voltage range | Vсм | $\begin{gathered} 3,4, \\ 8,9 \end{gathered}$ | － | 0 | － | Vcc－1．8 | V |
|  | Voltage gain | Av | 5，7 | DC | － | 100＊ | － | dB |
|  | Frequency bandwidth | BW | 5， 7 | $A V=0 \mathrm{~dB}$ | － | 2＊ | － | MHz |
|  | Output voltage | $\mathrm{V}_{\text {FbH }}$ | 5，7 | － | 4.7 | 4.9 | － | V |
|  |  | Vfbl | 5，7 | － | － | 20 | 200 | mV |
|  | Output source current | Isource | 5，7 | $\mathrm{FB} 1=\mathrm{FB} 2=2 \mathrm{~V}$ | － | －2 | －1 | mA |
|  | Output sink current | IsINK | 5， 7 | $\mathrm{FB} 1=\mathrm{FB} 2=2 \mathrm{~V}$ | 150 | 300 | － | $\mu \mathrm{A}$ |

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| Parameter |  | Symbol | Pin No. | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min |  |  | Typ | Max |  |
| 5-2. <br> Error amplifier block [Error Amp3] | Threshold voltage |  | $\mathrm{V}_{\text {TH1 }}$ | 16 | FB3 $=2 \mathrm{~V}, \mathrm{Ta}=+25^{\circ} \mathrm{C}$ | 4.183 | 4.200 | 4.225 | V |
|  |  | $\mathrm{V}_{\text {TH2 }}$ | 16 | $\begin{aligned} & \text { FB3 }=2 \mathrm{~V}, \\ & \mathrm{Ta}=-10^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | 4.169 | 4.200 | 4.231 | V |
|  | Input current | linez | 16 | - INE3 $=0 \mathrm{~V}$ | -100 | -30 | - | nA |
|  | Voltage gain | Av | 15 | DC | - | 100* | - | dB |
|  | Frequency bandwidth | BW | 15 | $\mathrm{AV}=0 \mathrm{~dB}$ | - | 2* | - | MHz |
|  | Output voltage | $\mathrm{V}_{\text {fb }}$ | 15 | - | 4.7 | 4.9 | - | V |
|  |  | $V_{\text {fbL }}$ | 15 | - | - | 20 | 200 | mV |
|  | Output source current | Isource | 15 | FB3 $=2 \mathrm{~V}$ | - | -2 | -1 | mA |
|  | Output sink current | Isink | 15 | FB3 $=2 \mathrm{~V}$ | 150 | 300 | - | $\mu \mathrm{A}$ |
|  | OUTD terminal output leak current | ILeak | 11 | OUTD $=17 \mathrm{~V}$ | - | 0 | 1 | $\mu \mathrm{A}$ |
|  | OUTD terminal output ON resistor | Ron | 11 | OUTD $=1 \mathrm{~mA}$ | - | 35 | 50 | $\Omega$ |
| 6. Current detection amplifier block [CurrentAmp1, Current Amp2] | Input offset voltage | Vıo | $\begin{gathered} 1, \\ 12, \\ 13, \\ 24 \end{gathered}$ | $\begin{aligned} & + \text { INC1 }=+\operatorname{INC2}=-\operatorname{INC} 1 \\ & =-\operatorname{INC2}=3 \mathrm{~V} \text { to VCC } \end{aligned}$ | -3 | - | +3 | mV |
|  | Input current | I+INCH | $\begin{aligned} & 13, \\ & 24 \end{aligned}$ | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 3 \mathrm{~V} \text { to VCC, } \\ & \Delta \mathrm{VIN}=-100 \mathrm{mV} \end{aligned}$ | - | 20 | 30 | $\mu \mathrm{A}$ |
|  |  | I-Inch | 1,12 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 3 \mathrm{~V} \text { to VCC, } \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | - | 0.1 | 0.2 | $\mu \mathrm{A}$ |
|  |  | I+INCL | $\begin{aligned} & 13, \\ & 24 \end{aligned}$ | $\begin{aligned} & +\mathrm{INC} 1=+\mathrm{INC2}=0 \mathrm{~V}, \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | -180 | -120 | - | $\mu \mathrm{A}$ |
|  |  | I-Incl | 1,12 | $\begin{aligned} & +\mathrm{INC} 1=+\mathrm{INC2}=0 \mathrm{~V}, \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | -195 | -130 | - | $\mu \mathrm{A}$ |

*: Standard design value
(Continued)

| Parameter |  | Symbol | PinNo. | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min |  |  | Typ | Max |  |
| 6. <br> Current detection amplifier block [Current Amp1, Current Amp2] | Current detection voltage |  | Voutci | 2, 10 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 3 \mathrm{~V} \text { to VCC, } \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | 1.9 | 2.0 | 2.1 | V |
|  |  | Voutc2 | 2,10 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 3 \mathrm{~V} \text { to VCC, } \\ & \Delta \mathrm{Vin}=-20 \mathrm{mV} \end{aligned}$ | 0.34 | 0.40 | 0.46 | V |
|  |  | Voutc3 | 2, 10 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 0 \mathrm{~V} \text { to 3 } \mathrm{V}, \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | 1.8 | 2.0 | 2.2 | V |
|  |  | Voutca | 2,10 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 0 \vee \text { to 3 } \mathrm{V}, \\ & \Delta \mathrm{Vin}=-20 \mathrm{mV} \end{aligned}$ | 0.2 | 0.4 | 0.6 | V |
|  | In-phase input voltage range | Vcm | $\begin{gathered} 1, \\ 12, \\ 13, \\ 24 \end{gathered}$ | - | 0 | - | Vcc | V |
|  | Voltage gain | Av | 2, 10 | $\begin{aligned} & + \text { INC1 }=+ \text { INC2 }= \\ & 3 \mathrm{~V} \text { to VCC, } \\ & \Delta \mathrm{Vin}=-100 \mathrm{mV} \end{aligned}$ | 19 | 20 | 21 | V/V |
|  | Frequency bandwidth | BW | 2, 10 | $\mathrm{AV}=0 \mathrm{~dB}$ | - | 2* | - | MHz |
|  | Output voltage | Voutch | 2, 10 | - | 4.7 | 4.9 | - | V |
|  |  | Voutcl | 2,10 | - | - | 20 | 200 | mV |
|  | Output source current | Isource | 2, 10 | OUTC1 $=$ OUTC2 $=2 \mathrm{~V}$ | - | -2 | -1 | mA |
|  | Output sink current | Isink | 2, 10 | OUTC1 $=$ OUTC2 $=2 \mathrm{~V}$ | 150 | 300 | - | $\mu \mathrm{A}$ |
| 7. <br> PWM comparator block [PWM Comp.] | Threshold voltage | Vtı | $\begin{gathered} 5,7, \\ 15 \end{gathered}$ | Duty cycle $=0 \%$ | 1.4 | 1.5 | - | V |
|  |  | $V_{\text {th }}$ | $\begin{gathered} 5,7, \\ 15 \end{gathered}$ | Duty cycle $=100 \%$ | - | 2.5 | 2.6 | V |

*: Standard design value
(Continued)

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\left(\mathrm{Ta}=+25^{\circ} \mathrm{C}, \mathrm{VCC}=19 \mathrm{~V}, \mathrm{VCC}(\mathrm{O})=19 \mathrm{~V}, \mathrm{VREF}=0 \mathrm{~mA}\right)
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| Parameter |  | $\begin{gathered} \text { Sym- } \\ \text { bol } \end{gathered}$ | Pin <br> No. | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min |  |  | Typ | Max |  |
| 8. Output block [OUT] | Output source current |  | Isource | 20 | $\begin{aligned} & \begin{array}{l} \text { OUT }=13 \mathrm{~V}, \text { Duty } \leq 5 \% \\ (\mathrm{t}=1 / \mathrm{fosc} \times \text { Duty }) \end{array} \end{aligned}$ | - | -400* | - | mA |
|  | Output sink current | Isink | 20 | $\begin{aligned} & \text { OUT = } 19 \mathrm{~V}, \text { Duty } \leq 5 \% \\ & (\mathrm{t}=1 / \text { fosc } \times \text { Duty }) \end{aligned}$ | - | 400* | - | mA |
|  | Output ON resistor | Rон | 20 | OUT $=-45 \mathrm{~mA}$ | - | 6.5 | 9.8 | $\Omega$ |
|  |  | RoL | 20 | OUT $=45 \mathrm{~mA}$ | - | 5.0 | 7.5 | $\Omega$ |
|  | Rise time | tr1 | 20 | $\begin{aligned} & \text { OUT }=3300 \mathrm{pF} \\ & (\mathrm{Si} 4435 \times 1) \end{aligned}$ | - | 50* | - | ns |
|  | Fall time | tf1 | 20 | $\begin{aligned} & \text { OUT }=3300 \mathrm{pF} \\ & (\mathrm{Si4435} \times 1) \end{aligned}$ | - | 50* | - | ns |
| 9. <br> Power supply control block [CTL] | CTL input voltage | Von | 14 | IC Active mode | 2 | - | 25 | V |
|  |  | Voff | 14 | IC Standby mode | 0 | - | 0.8 | V |
|  | Input current | Iст내 | 14 | CTL $=5 \mathrm{~V}$ | - | 100 | 150 | $\mu \mathrm{A}$ |
|  |  | Ictul | 14 | $\mathrm{CTL}=0 \mathrm{~V}$ | - | 0 | 1 | $\mu \mathrm{A}$ |
| 10. <br> Bias voltage block [VH] | Output voltage | V | 19 | $\begin{aligned} & \mathrm{VCC}=\mathrm{VCC}(\mathrm{O}) \\ & =8 \mathrm{~V} \text { to } 25 \mathrm{~V}, \\ & \mathrm{VH}=0 \text { to } 30 \mathrm{~mA} \end{aligned}$ | Vcc-6.5 | Vcc-6.0 | Vcc-5.5 | V |
| 11. <br> General | Standby current | Iccs | 18 | $\begin{aligned} & \mathrm{VCC}=\mathrm{VCC}(\mathrm{O}), \\ & \mathrm{CTL}=0 \mathrm{~V} \end{aligned}$ | - | 0 | 10 | $\mu \mathrm{A}$ |
|  | Power supply current | Icc | 18 | $\begin{aligned} & \mathrm{VCC}=\mathrm{VCC}(\mathrm{O}), \\ & \mathrm{CTL}=5 \mathrm{~V} \end{aligned}$ | - | 8 | 12 | mA |

[^1]
## TYPICAL CHARACTERISTICS

Power supply current vs. Power supply voltage


Power supply voltage Vcc (V)
Reference voltage vs. Reference voltage output current


CTL terminal current, Reference voltage vs. CTL terminal voltage


Reference voltage $\mathrm{V}_{\text {ref }}$ (V)

Reference voltage vs. Power supply voltage


Reference voltage vs. Ambient temperature

(Continued)

## MB3887


(Continued)


Current detection amplifier gain and phase vs. Frequency

(Continued)

## MB3887

(Continued)

Power dissipation vs. Ambient temperature


## ■ FUNCTIONAL DESCRIPTION

## 1. DC/DC Converter Unit

(1) Reference voltage block (Ref)

The reference voltage generator uses the voltage supplied from the VCC terminal (pin 18) to generate a tem-perature-compensated, stable voltage ( 5.0 V Typ) used as the reference supply voltage for the IC's internal circuitry.
This terminal can also be used to obtain a load current to a maximum of 1 mA from the reference voltage VREF terminal (pin 6).

## (2) Triangular wave oscillator block (OSC)

The triangular wave oscillator builds the capacitor for frequency setting into, and generates the triangular wave oscillation waveform by connecting the frequency setting resistor with the RT terminal (pin 17) .
The triangular wave is input to the PWM comparator on the IC.

## (3) Error amplifier block (Error Amp1)

This amplifier detects the output signal from the current detection amplifier (Current amp1), compares this to the +INE1 terminal (pin 9), and outputs a PWM control signal to be used in controlling the charging current.
In addition, an arbitrary loop gain can be set up by connecting a feedback resistor and capacitor between the FB1 terminal (pin 7) and -INE1 terminal (pin 8), providing stable phase compensation to the system.

## (4) Error amplifier block (Error Amp2)

This amplifier (Error Amp2) detects voltage drop of the AC adapter and outputs a PWM control signal.
In addition, an arbitrary loop gain can be set by connecting a feedback resistor and capacitor from the FB2 terminal (pin 5) to the -INE2 terminal (pin 4) of the error amplifier, enabling stable phase compensation to the system.

## (5) Error amplifier block (Error Amp3)

This error amplifier (Error Amp3) detects the output voltage from the DC/DC converter and outputs the PWM control signal. External output voltage setting resistors can be connected to the error amplifier inverted input terminal to set the desired level of output voltage from 1 cell to 4 cells.

In addition, an arbitrary loop gain can be set by connecting a feedback resistor and capacitor from the FB3 terminal (pin 15) to the -INE3 terminal (pin 16) of the error amplifier, enabling stable phase compensation to the system.
Connecting a soft-start capacitor to the CS terminal (pin 22) prevents rush currents when the IC is turned on.
Using an error amplifier for soft-start detection makes the soft-start time constant, independent of the output load.

## (6) Current detection amplifier block (Current Amp1)

The current detection amplifier (Current Amp1) detects a voltage drop which occurs between both ends of the output sense resistor (Rs) due to the flow of the charge current, using the +INC1 terminal (pin 13) and -INC1 terminal (pin 12). Then it outputs the signal amplified by 20 times to the error amplifier (Error Amp1) at the next stage.

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## (7) PWM comparator block (PWM Comp.)

The PWM comparator circuit is a voltage-pulse width converter for controlling the output duty of the error amplifiers (Error Amp1 to Error Amp3) depending on their output voltage.
The PWM comparator circuit compares the triangular wave generated by the triangular wave oscillator to the error amplifier output voltage and turns on the external output transistor during the interval in which the triangular wave voltage is lower than the error amplifier output voltage.

## (8) Output block (OUT)

The output circuit uses a totem-pole configuration capable of driving an external P-channel MOS FET.
The output " L " level sets the output amplitude to 6 V ( Typ ) using the voltage generated by the bias voltage block (VH).
This results in increasing conversion efficiency and suppressing the withstand voltage of the connected external transistor in a wide range of input voltages.

## (9) Control block (CTL)

Setting the CTL terminal (pin 14) low places the IC in the standby mode. (The supply current is $10 \mu \mathrm{~A}$ at maximum in the standby mode.)

CTL function table

| CTL | Power | OUTD |
| :---: | :---: | :---: |
| L | OFF (Standby) | Hi-Z |
| $H$ | ON (Active) | L |

(10) Bias voltage block (VH)

The bias voltage circuit outputs $\mathrm{V}_{\mathrm{cc}}-6 \mathrm{~V}$ (Typ) as the minimum potential of the output circuit. In the standby mode, this circuit outputs the potential equal to VCC.

## 2. Protection Functions

## Under voltage lockout protection circuit (UVLO)

The transient state or a momentary decrease in supply voltage or internal reference voltage (VREF), which occurs when the power supply (VCC) is turned on, may cause malfunctions in the control IC, resulting in breakdown or degradation of the system.

To prevent such malfunction, the under voltage lockout protection circuit detects a supply voltage or internal reference voltage drop and fixes the OUT terminal (pin 20) to the "H" level. The system restores voltage supply when the supply voltage or internal reference voltage reaches the threshold voltage of the under voltage lockout protection circuit.

## Protection circuit (UVLO) operation function table

When UVLO is operating (VCC or VREF voltage is lower than UVLO threshold voltage.)

| OUTD | OUT | CS |
| :---: | :---: | :---: |
| $\mathrm{Hi}-\mathrm{Z}$ | H | L |

## 3. Soft-Start Function

## Soft-start block (SOFT)

Connecting a capacitor to the CS terminal (pin 22) prevents rush currents when the IC is turned on. Using an error amplifier for soft-start detection makes the soft-start time constant, being independent of the output load of the $\mathrm{DC} / \mathrm{DC}$ converter.

## ■ SETTING THE CHARGING VOLTAGE

The charging voltage (DC/DC output voltage) can be set by connecting external voltage setting resistors (R3, R4) to the -INE3 terminal (pin 16). Be sure to select a resistor value that allows you to ignore the on-resistor ( $35 \Omega, 1 \mathrm{~mA}$ ) of the internal FET connected to the OUTD terminal (pin 11). In standby mode, the charging voltage is applied to OUTD termial. Therefore, output voltage must be adjusted so that voltage applied to OUTD terminal (pin 11) is 17 V or less.
Battery charging voltage : Vo

$$
V_{0}(V)=(R 3+R 4) / R 4 \times 4.2(V)
$$



## METHOD OF SETTING THE CHARGING CURRENT

The charge current (output limit current) value can be set with the voltage at the +INE1 terminal (pin 9) .
If a current exceeding the set value attempts to flow, the charge voltage drops according to the set current value.

Battery charge current setting voltage : +INE1

$$
+\operatorname{INE} 1(\mathrm{~V})=20 \times \operatorname{I1}(\mathrm{A}) \times \operatorname{Rs}(\Omega)
$$

## METHOD OF SETTING THE TRIANGULAR WAVE OSCILLATION FREQUENCY

The triangular wave oscillation frequency can be set by the timing resistor ( $\mathrm{R}_{\mathrm{T}}$ ) connected the RT terminal (pin 17).

Triangular wave oscillation frequency : fosc
fosc $(k H z) \div 13630 / R T(k \Omega)$

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## METHOD OF SETTING THE SOFT-START TIME

For preventing rush current upon activation of IC, the IC allows soft-start using the capacitor (Cs) connected to the CS terminal (pin 22).
When CTL terminal (pin 14) is placed under " H " level and IC is activated (Vcc $\geq$ UVLO threshold voltage), Q2 is turned off and the external soft-start capacitor (Cs) connected to the CS terminal is charged at $10 \mu \mathrm{~A}$.
Error Amp output (FB3 terminal (pin 15) ) is determined by comparison between the lower voltage of the two non-reverse input terminals ( 4.2 V and CS terminal voltage) and reverse input terminal voltage (-INE3 terminal (pin 16) voltage). Within the soft-start period (CS terminal voltage $<4.2 \mathrm{~V}$ ), FB3 is determined by comparison between -INE3 terminal voltage and CS terminal voltage, and DC/DC converter output voltage goes up proportionately with the increase of CS terminal voltage caused by charging on the soft-start capacitor. Soft-start time is found by the following formula :

Soft-start time : ts (time to output $100 \%$ )
ts $(\mathrm{s}) \div 0.42 \times \mathrm{Cs}(\mu \mathrm{F})$


Soft-start time: ts


Soft-start circuit

## AC ADAPTOR VOLTAGE DETECTION

- With an external resistor connected to the +INE2 terminal (pin 3) , the IC enters the dynamically-controlled charging mode to reduce the charge current to keep AC adapter power constant when the partial potential point A of the AC adapter voltage (VCC) becomes lower than the voltage at the -INE2 terminal.

AC adapter detection voltage setting : Vth

$$
\text { Vth }(V)=(R 1+R 2) / R 2 \times-\operatorname{INE} 2
$$



## OPERATION TIMING DIAGRAM



## MB3887

## PROCESSING WITHOUT USING THE CURRENT AMP

When Current Amp is not used, connect the +INC1 terminal (pin 13) , +INC2 terminal (pin 24) , -INC1 terminal (pin 12) , and -INC2 terminal (pin 1) to VREF, and then leave OUTC1 terminal (pin 10) and OUTC2 terminal (pin 2) open.


Connection when Current Amp is not used

## ■ PROCESSING WITHOUT USING OF THE ERROR AMP

When Error Amp is not used, leave FB1 terminal (pin 7) , FB2 terminal (pin 5) open and connect the -INE1 terminal (pin 8) and -INE2 terminal (pin 4) to GND and connect +INE1 terminal (pin 9) , and +INE2 terminal (pin 3) , to VREF.


## PROCESSING WITHOUT USING OF THE CS TERMINAL

When soft-start function is not used, leave the CS terminal (pin 22) open.


Connection when soft-start time is not specified

## NOTE ON AN EXTERNAL REVERSE-CURRENT PREVENTIVE DIODE

- Insert a reverse-current preventive diode at one of the three locations marked * to prevent reverse current from the battery.
- When selecting the reverse current prevention diode, be sure to consider the reverse voltage $\left(\mathrm{V}_{\mathrm{R}}\right)$ and reverse current (IR) of the diode.



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## THE SEQUENCE OF THE START-UP AND OFF OF THE POWER SUPPLY

Please start up and off the VCC terminal (pin 18) and VCC(O) terminal (pin 21) of the power supply terminal at the same time. No do occurrence of the bias from the VH terminal (pin 19), when there is a period of 8 V or less in the VCC voltage after previously starting up VCC(O). At this time, there is a possibility of leading to permanent destruction of the device when the voltage of 17 V or more is impressed to the $\mathrm{VCC}(\mathrm{O})$ terminal (pin 21). Moreover, when earliness VCC falls more than VCC( O ) when falling, it is similar.

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## APPLICATION EXAMPLE



## PARTS LIST

| COMPONENT | ITEM | SPECIFICATION |  | VENDOR | PARTS No. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Q1 } \\ & \text { Q2 } \end{aligned}$ | P-ch FET <br> N -ch FET | $\begin{gathered} \text { VDS }=-30 \mathrm{~V}, \mathrm{ID}= \pm 8 \mathrm{~A}(\mathrm{Max}) \\ \mathrm{VDS}=60 \mathrm{~V}, \mathrm{ID}=0.115 \mathrm{~A} \\ (\mathrm{Max}) \end{gathered}$ |  | VISHAY SILICONIX VISHAY SILICONIX | $\begin{aligned} & \text { Si4435DY } \\ & \text { 2N7002E } \end{aligned}$ |
| D1 | Diode | $\mathrm{VF}=0.42 \mathrm{~V}$ (Max) , IF $=3 \mathrm{~A}$ |  | ROHM | RB053L-30 |
| L1 | Inductor | $22 \mu \mathrm{H}$ | $\begin{gathered} 3.5 \mathrm{~A}, 31.6 \\ \mathrm{~m} \Omega \end{gathered}$ | TDK | $\begin{aligned} & \text { SLF12565T- } \\ & \text { 220M3R5 } \end{aligned}$ |
| C1 | OS-CON ${ }^{\text {™ }}$ | $22 \mu \mathrm{~F}$ | 25 V (10\%) | SANYO | 25SL22M |
| C2, C3 | Electrolytic Condenser | $100 \mu \mathrm{~F}$ | $25 \mathrm{~V}(10 \%)$ | SANYO | 25CV100AX |
| C4 | Ceramics Condenser | $0.022 \mu \mathrm{~F}$ | 50 V | TDK | C1608JB1H223K |
| C5 | Ceramics Condenser | $0.1 \mu \mathrm{~F}$ | 16 V | KYOCERA | CM21W5R104K16 |
| C6 | Ceramics Condenser | 1500 pF | 10 V | MURATA | GRM39B152K10 |
| C7 | Ceramics Condenser | $0.1 \mu \mathrm{~F}$ | 25 V | MURATA | GRM39F104KZ25 |
| C8 | Ceramics Condenser | 10000 pF | 10 V | MURATA | GRM39B103K10 |
| C9 | Ceramics Condenser | $0.1 \mu \mathrm{~F}$ | 16 V | KYOCERA | CM21W5R104K16 |
| C10 | Ceramics Condenser | 5600 pF | 10 V | MURATA | GRM39B562K10 |
| R1 | Resistor | $0.033 \Omega$ | 1.0 \% | SEIDEN TECHNO | RK73Z1J-0D |
| R2 | Resistor | $47 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-473D |
| R3 | Resistor | $330 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-334D |
| R4 | Resistor | $82 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-823D |
| R5 | Resistor | $330 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-334D |
| R6 | Resistor | $68 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-683D |
| R7 | Resistor | $22 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-223D |
| R8 | Resistor | $100 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-104D |
| R9 | Resistor | $10 \mathrm{k} \Omega$ | 1.0 \% | KYOCERA | CR21-103-F |
| R10 to R12 | Resistor | $30 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-303D |
| R13 | Resistor | $20 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-203D |
| R14 | Resistor | $1 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-102D |
| R15 | Resistor | $120 \Omega$ | 0.5 \% | ssm | RR0816P121D |
| R16, R18 | Resistor | $200 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-204D |
| R17, R19 | Resistor | $100 \mathrm{k} \Omega$ | 0.5 \% | KOA | RK73G1J-104D |

Note : VISHAY SILICONIX : VISHAY Intertechnology, Inc.
ROHM : ROHM CO., LTD.
TDK : TDK Corporation
SANYO : SANYO Electric Co., Ltd.
KYOCERA : Kyocera Corporation
MURATA : Murata Manufacturing Co., Ltd.
SEIDEN TECHNO : SEIDEN TECHNO CO., LTD.
KOA : KOA Corporation
ssm : SUSUMU Co., Ltd.
OS-CON is a trademark of SANYO Electric Co., Ltd.

## REFERENCE DATA

Conversion efficiency vs. BATT charge current (Constant voltage mode)


Conversion efficiency vs. BATT charge current (Constant voltage mode)


Conversion efficiency vs. BATT charge voltage (Constant current mode)


Conversion efficiency vs. BATT charge voltage (Constant current mode)

(Continued)
(Continued)

Switching waveform constant voltage mode (set at 12.6 V )


Switching waveform constant voltage mode (set at 16.8 V )


Switching waveform constant current mode
(set at 12.6 V , with 10 V )


Switching waveform constant current mode (set at 16.8 V , with 10 V )


Soft-start operating waveform constant voltage mode
(set at 12.6 V )


Soft-start operating waveform constant voltage mode (set at 16.8 V )


Discharge operating waveform constant voltage mode
(set at 12.6 V )


Discharge operating waveform constant voltage mode
(set at 16.8 V )
Vbatt (V)


## USAGE PRECAUTIONS

- Printed circuit board ground lines should be set up with consideration for common impedance.
- Take appropriate static electricity measures.
- Containers for semiconductor materials should have anti-static protection or be made of conductive material.
- After mounting, printed circuit boards should be stored and shipped in conductive bags or containers.
- Work platforms, tools, and instruments should be properly grounded.
- Working personnel should be grounded with resistance of $250 \mathrm{k} \Omega$ to $1 \mathrm{M} \Omega$ between body and ground.
- Do not apply negative voltages.
- The use of negative voltages below -0.3 V may create parasitic transistors on LSI lines, which can cause malfunction.


## ORDERING INFORMATION

| Part number | Package | Remarks |
| :--- | :---: | :---: |
| MB3887PFV-aun | 24-pin plastic SSOP <br> (FPT-24P-M03) | Conventional version |
| MB3887PFV-DE1 | 24-pin plastic SSOP <br> (FPT-24P-M03) | Lead Free version |

## ■ RoHS Compliance Information of Lead (Pb) Free version

The LSI products of Fujitsu with "E1" are compliant with RoHS Directive, and has observed the standard of lead, cadmium, mercury, Hexavalent chromium, polybrominated biphenyls (PBB) , and polybrominated diphenyl ethers (PBDE) .

The product that conforms to this standard is added "E1" at the end of the part number.

## MARKING FORMAT (Lead Free version)



## LABELING SAMPLE (Lead free version)



MB3887PFV-DDE1 Recommended Conditions of Moisture Sensitivity Level

| Item | Condition |  |
| :---: | :---: | :---: |
| Mounting Method | IR (infrared reflow), Manual soldering (partial heating method) |  |
| Mounting times | 2 times |  |
| Storage period | Before opening | Please use it within two years after <br> Manufacture. |
|  | From opening to the 2nd <br> reflow | Less than 8 days |
|  | When the storage period after <br> opening was exceeded | Please processes within 8 days <br> after baking (125 $\left.{ }^{\circ} \mathrm{C}, 24 \mathrm{H}\right)$ |
| Storage conditions | $5^{\circ} \mathrm{C}$ to $30^{\circ} \mathrm{C}, 70 \% \mathrm{RH}$ or less (the lowest possible humidity) |  |

[Temperature Profile for FJ Standard IR Reflow]
(1) IR (infrared reflow)

(a) Temperature Increase gradient : Average $1^{\circ} \mathrm{C} / \mathrm{s}$ to $4^{\circ} \mathrm{C} / \mathrm{s}$
(b) Preliminary heating : Temperature $170^{\circ} \mathrm{C}$ to $190^{\circ} \mathrm{C}, 60 \mathrm{~s}$ to 180 s
(c) Temperature Increase gradient : Average $1^{\circ} \mathrm{C} / \mathrm{s}$ to $4^{\circ} \mathrm{C} / \mathrm{s}$
(d) Actual heating
: Temperature $260^{\circ} \mathrm{C}$ Max; $255^{\circ} \mathrm{C}$ or more, 10 s or less
(d')
: Temperature $230^{\circ} \mathrm{C}$ or more, 40 s or less or
Temperature $225^{\circ} \mathrm{C}$ or more, 60 s or less
or
Temperature $220^{\circ} \mathrm{C}$ or more, 80s or less
(e) Cooling : Natural cooling or forced cooling

Note : Temperature : the top of the package body
(2) Manual soldering (partial heating method)

Conditions : Temperature $400^{\circ} \mathrm{C} \mathrm{Max}$
Times : 5 s max/pin

## PACKAGE DIMENSION

| 24-pin plastic SSOP | Lead pitch | 0.65 mm |
| :---: | :---: | :---: |
| Package width $\times$ <br> package length | $5.6 \times 7.75 \mathrm{~mm}$ |  |
|  | Lead shape | Sullwing |
|  | Sealing method <br> (FPT-24P-M03) | Weignting height <br> (Reference) |



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#### Abstract

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[^0]:    ＊：Standard design value．

[^1]:    * : Standard design value

